

ET3203

End Termination

Description

ET3203 is a low silver, nickel plateable, end termination. It is designed to be compatible on inductor bodies, multi-layer varistors and multilayer ceramic chip capacitors (NPO and X7R bodies). Nickel plating can be done without pre-plate processing due to the low glass content on the fired surface.

Key Features

- Low Ag content (63 %) Nickel plateable no pre-plate processing Low usage excellent coverage uniformity Dense fired microstructure



This picture does not show the packaging of ET3203 and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.

Typical Properties

Viscosity	25 – 35 Kcps Brookfield RVT SC4 – 14 spindle, 6R utility cup at 10 rpm, 25 °C
Solids	83.0 ± 1.0 %
Metal	Ag

Recommended Processing Guide

Process Temperature (TDS)	650 – 800 °C peak temperature Dwell time at temp. 5 – 7 minutes
Recommended Thinner	RV-372

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Warranty

6 months

Storage

Store in a dry location at 20 – 25 °C.

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